# **Four-Bit Universal Shift** Register

### Description

The MC10H141 is a four-bit universal shift register. This device is a functional/pinout duplication of the standard MECL 10K<sup>™</sup> part with 100% improvement in propagation delay and operation frequency and no increase in power supply current.

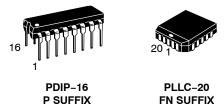
### Features

- Shift frequency, 250 MHz Min
- Power Dissipation, 425 mW Typical
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K Compatible
- These Devices are Pb-Free, Halogen Free and are RoHS Compliant



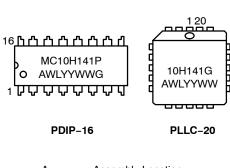
# **ON Semiconductor®**

www.onsemi.com



CASE 648-08

**FN SUFFIX** CASE 775-02



**MARKING DIAGRAMS\*** 

= Assembly Location Α WL, L = Wafer Lot YY. Y = Year WW, W = Work Week G = Pb-Free Package

\*For additional marking information, refer to Application Note AND8002/D.

### **ORDERING INFORMATION**

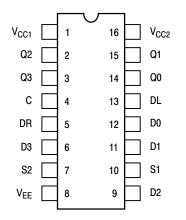
Device	Package	Shipping†
MC10H141FNR2G	PLLC-20 (Pb-Free)	500 Tape & Reel
MC10H141PG	PDIP-16 (Pb-Free)	25 Units / Tube

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

### Table 1. TRUTH TABLE

SELECT			OUTPUTS				
S1	S2	MODE	Q0 <sub>n + 1</sub>	Q1 <sub>n + 1</sub>	Q2 <sub>n + 1</sub>	Q3 <sub>n + 1</sub>	
L	L	Parallel Entry	D0	D1	D2	D3	
L	Н	Shift Right*	Q1 <sub>n</sub>	Q2 <sub>n</sub>	Q3 <sub>n</sub>	DR	
н	L	Shift Left*	DL	Q0 <sub>n</sub>	Q1 <sub>n</sub>	Q2 <sub>n</sub>	
н	н	Stop Shift	Q0 <sub>n</sub>	Q1 <sub>n</sub>	Q2 <sub>n</sub>	32 <sub>n</sub>	

Outputs as exist after pulse appears at "C" input with input conditions as shown (Pulse Positive transition of clock input).



Pin assignment is for Dual-in-Line Package.



### Table 2. MAXIMUM RATINGS

Symbol	Characteristic	Rating	Unit
V <sub>EE</sub>	Power Supply (V <sub>CC</sub> = 0)	-8.0 to 0	Vdc
VI	Input Voltage (V <sub>CC</sub> = 0)	0 to V <sub>EE</sub>	Vdc
l <sub>out</sub>	Output Current – Continuous – Surge	50 100	mA
T <sub>A</sub>	Operating Temperature Range	0 to +75	°C
T <sub>stg</sub>	Storage Temperature Range – Plastic – Ceramic	–55 to +150 –55 to +165	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

### Table 3. ELECTRICAL CHARACTERISTICS (V<sub>EE</sub> = -5.2 V $\pm 5\%$ (Note 1)

		0° 25°		5°	<b>75</b> °			
Symbol	Characteristic	Min	Max	Min	Max	Min	Max	Unit
Ι <sub>Ε</sub>	Power Supply Current	-	112	-	102	-	112	mA
l <sub>inH</sub>	Input Current High Pins 5,6,9,11,12,13 Pins 7,10 Pin 4	- - -	405 416 510	- - -	255 260 320	- - -	255 260 320	μΑ
I <sub>inL</sub>	Input Current Low	0.5	-	0.5	-	0.3	-	μΑ
V <sub>OH</sub>	High Output Voltage	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
V <sub>OL</sub>	Low Output Voltage	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
V <sub>IH</sub>	High Input Voltage	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
V <sub>IL</sub>	Low Input Voltage	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

1. Each MECL 10H<sup>™</sup> series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50 Ω resistor to −2.0 V.

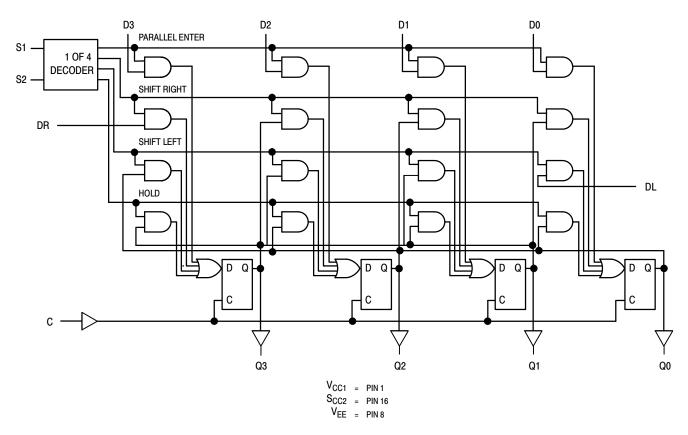
### Table 4. AC PARAMETERS

t <sub>pd</sub>	Propagation Delay	1.0	2.0	1.0	2.0	1.1	2.1	ns
t <sub>hold</sub>	Hold Time Data, Select	1.0	-	1.0	-	1.0	-	ns
t <sub>set</sub>	Set-up Time Data Select	1.5 3.0	-	1.5 3.0	-	1.5 3.0	-	ns
t <sub>r</sub>	Rise Time	0.5	2.4	0.5	2.4	0.5	2.4	ns
t <sub>f</sub>	Fall Time	0.5	2.4	0.5	2.4	0.5	2.4	ns
f <sub>shift</sub>	Shift Frequency	250	-	250	-	250	-	MHz

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

# MC10H141

### LOGIC DIAGRAM

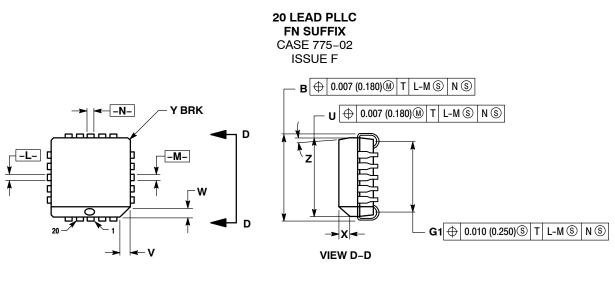


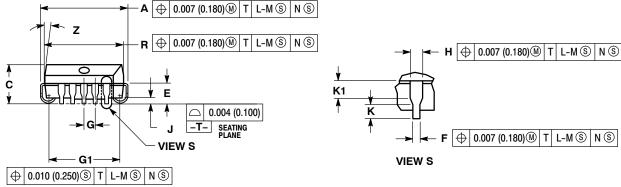
## **APPLICATION INFORMATION**

The MC10H141 is a four-bit universal shift register which performs shift left, or shift right, serial/parallel in, and serial/parallel out operations with no external gating. Inputs S1 and S2 control the four possible operations of the register without external gating of the clock. The flip-flops shift information on the positive edge of the clock. The four operations are stop shift, shift left, shift right, and parallel entry of data. The other six inputs are all data type inputs; four for parallel entry data, and one for shifting in from the left (DL) and one for shifting in from the right (DR).

### MC10H141

#### PACKAGE DIMENSIONS





NOTES

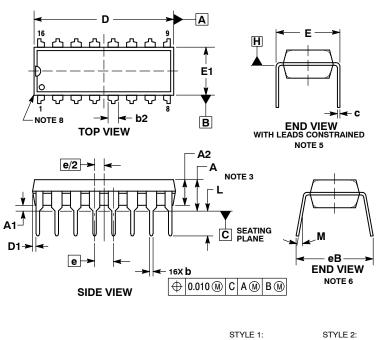
- 1. DIMENSIONS AND TOLERANCING PER ANSI Y14.5M, 1982
- DIMENSIONS IN INCHES.
  DATUMS -L-, -M-, AND -N- DETERMINED WHERE TOP OF LEAD SHOULDER EXITS PLASTIC BODY AT MOLD DETERMINE UNIT PARTING LINE.

- PARTING LINE.
  DIMENSION G1, TRUE POSITION TO BE MEASURED AT DATUM -T-, SEATING PLANE.
  DIMENSIONS R AND U DO NOT INCLUDE MOLD FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.
  DIMENSIONS IN THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO 0.012 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE
- MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY. 7. DIMENSION H DOES NOT INCLUDE DAMBAR PROTRUSION OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

	INCHES		MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.385	0.395	9.78	10.03	
В	0.385	0.395	9.78	10.03	
С	0.165	0.180	4.20	4.57	
Е	0.090	0.110	2.29	2.79	
F	0.013	0.021	0.33	0.53	
G	0.050	BSC	1.27	BSC	
н	0.026	0.032	0.66	0.81	
J	0.020		0.51		
Κ	0.025		0.64		
R	0.350	0.356	8.89	9.04	
U	0.350	0.356	8.89	9.04	
V	0.042	0.048	1.07	1.21	
W	0.042	0.048	1.07	1.21	
Х	0.042	0.056	1.07	1.42	
Υ		0.020		0.50	
Ζ	2 °	10 °	2 °	10 °	
G1	0.310	0.330	7.88	8.38	
K1	0.040		1.02		

#### PACKAGE DIMENSIONS

PDIP-16 **P SUFFIX** CASE 648-08 **ISSUE V** 



NOTES

CORNERS)

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M. 1994. CONTROLLING DIMENSION: INCHES
- 3
- DIMENSIONS A, A1 AND L ARE MEASURED WITH THE PACK-AGE SEATED IN JEDEC SEATING PLANE GAUGE GS-3. DIMENSIONS D, D1 AND E1 DO NOT INCLUDE MOLD FLASH 4 OR PROTRUSIONS. MOLD FLASH OR PROTRUSIONS ARE
- NOT TO EXCEED 0.10 INCH. DIMENSION E IS MEASURED AT A POINT 0.015 BELOW DATUM 5 PLANE H WITH THE LEADS CONSTRAINED PERPENDICULAR TO DATUM C.
- 6 DIMENSION eB IS MEASURED AT THE LEAD TIPS WITH THE LEADS UNCONSTRAINED. 7
- DATUM PLANE H IS COINCIDENT WITH THE BOTTOM OF THE LEADS, WHERE THE LEADS EXIT THE BODY. 8 PACKAGE CONTOUR IS OPTIONAL (ROUNDED OR SQUARE

	INCHES		MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α		0.210		5.33	
A1	0.015		0.38		
A2	0.115	0.195	2.92	4.95	
b	0.014	0.022	0.35	0.56	
b2	0.060 TYP		1.52 TYP		
С	0.008	0.014	0.20	0.36	
D	0.735	0.775	18.67	19.69	
D1	0.005		0.13		
Е	0.300	0.325	7.62	8.26	
E1	0.240	0.280	6.10	7.11	
е	0.100 BSC		2.54	BSC	
eВ		0.430		10.92	
Г	0.115	0.150	2.92	3.81	
Μ		10°		10°	

CATHODE COMMON DRAIN PIN 1. PIN 1. CATHODE CATHODE COMMON DRAIN 2 2 COMMON DRAIN З. З. CATHODE COMMON DRAIN 4. 4. COMMON DRAIN 5 CATHODE 5 CATHODE COMMON DRAIN 6. 6. CATHODE 7. COMMON DRAIN CATHODE ANODE 8 8. COMMON DRAIN GATE 9. 9. ANODE SOURCE 10. 10. 11. ANODE 11. GATE SOURCE 12 12. ANODE 13. 13. GATE ANODE SOURCE 14. 14. 15 ANODE 15 GATE ANODE SOURCE 16. 16.

#### MECL is trademark of Semiconductor Components Industries, LLC (SCILLC) or its subsidiaries in the United States and/or other countries.

ON Semiconductor and mare trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <a href="http://www.onsemi.com/site/pdf/Patent-Marking.pdf">www.onsemi.com/site/pdf/Patent-Marking.pdf</a>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typical" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

#### PUBLICATION ORDERING INFORMATION

#### LITERATURE FULFILLMENT

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support:

Phone: 421 33 790 2910 Japan Customer Focus Center Phone: 81-3-5817-1050

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative